

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Takashi Nakai et al.

Application No.: 10/596,004

Confirmation No.: 1629

Filed: May 21, 2007

Art Unit: 1793

For: WARM MOLDING RAW MATERIAL  
POWDER AND WARM MOLDING METHOD

Examiner: N. T. Mai

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Non-Final Office Action dated May 27, 2008, please enter the following amendments and consider the accompanying remarks.

It is believed that no fees are required for these submissions. However, should the U.S. Patent and Trademark Office determine that any fee is required or that any refund is owed for this application, the Commissioner is hereby authorized and requested to charge any deficiency and/or credit any refund owed to our Deposit Account No. 04-0100.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.